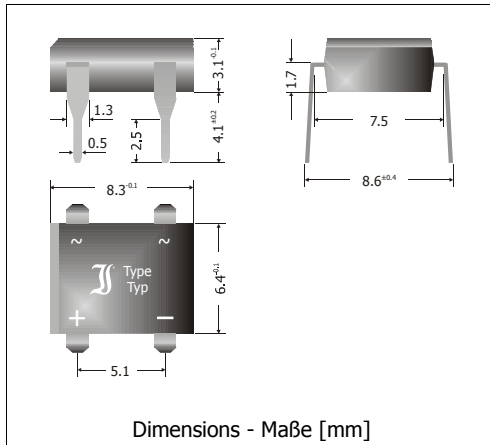


CS10D ... CS50D

Schottky-Bridge-Rectifiers Schottky-Brückengleichrichter

Version 2006-04-22



Nominal current Nennstrom	1 A
Alternating input voltage Eingangsschaltspannung	10...50 V
Plastic case DIL Kunststoffgehäuse DIL	8.3 x 6.4 x 3.1 [mm]
Weight approx. – Gewicht ca.	0.4 g
Plastic material has UL classification 94V-0 Gehäusematerial UL94V-0 klassifiziert	
Standard packaging: plastic tubes Standard Lieferform: Plastik-Schienen	



Recognized Product – Underwriters Laboratories Inc.® File E175067
Anerkanntes Produkt – Underwriters Laboratories Inc.® Nr. E175067

Maximum ratings and characteristics

Grenz- und Kennwerte

Type Typ	Repetitive peak reverse voltage Periodische Spitzensperrspannung V_{RRM} [V]	Surge peak reverse voltage Stoßspitzensperrspannung V_{RSM} [V]	Forward voltage Durchlass-Spannung V_F [V] ^{1,2)}
CS10D	10	10	< 0.50
CS20D	20	20	< 0.50
CS30D	30	30	< 0.50
CS40D	40	40	< 0.79
CS50D	50	50	< 0.79

Repetitive peak forward current Periodischer Spitzenstrom	$f > 15$ Hz	I_{FRM}	10 A ³⁾
Peak forward surge current, 50/60 Hz half sine-wave Stoßstrom für eine 50/60 Hz Sinus-Halbwellen	$T_A = 25^\circ\text{C}$	I_{FSM}	40/44 A
Rating for fusing, $t < 10$ ms Grenzlastintegral, $t < 10$ ms	$T_A = 25^\circ\text{C}$	i^2t	8 A ² s
Operating junction temperature – Sperrschichttemperatur		T_j	-50...+150°C
Storage temperature – Lagerungstemperatur		T_s	-50...+150°C

1 $I_F = 1$ A, $T_j = 25^\circ\text{C}$

2 Valid for one branch – Gültig für einen Brückenzweig

3 Max. temperature of the terminals $T_T = 100^\circ\text{C}$ – Max. Temperatur der Anschlüsse $T_T = 100^\circ\text{C}$

Characteristics

Max. average forward rectified current
Dauergrenzstrom

Leakage current
Sperrstrom

Thermal resistance junction to ambient air
Wärmewiderstand Sperrschicht – umgebende Luft

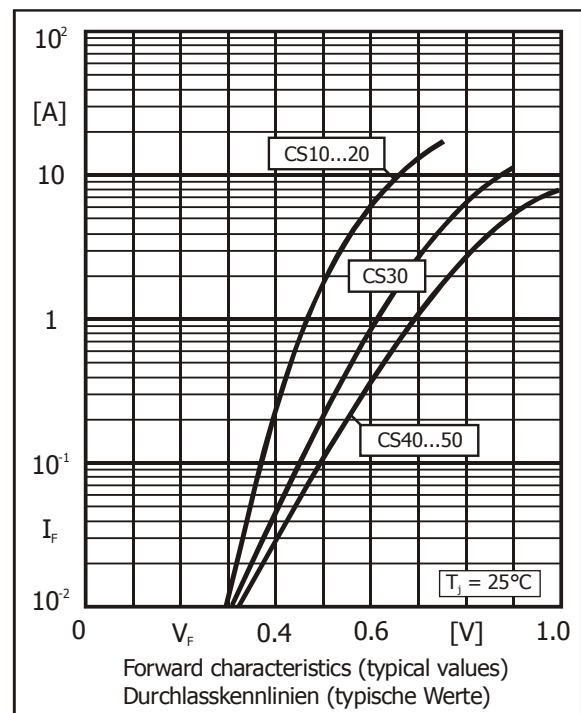
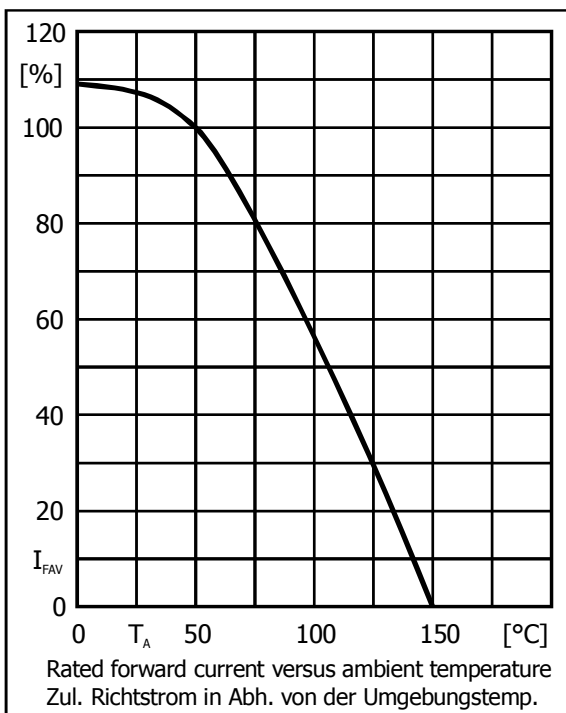
 $T_A = 50^\circ\text{C}$
 $T_j = 25^\circ\text{C}$
 $T_j = 100^\circ\text{C}$

R-load

C-load

 $V_R = V_{RRM}$
 $V_R = V_{RRM}$
 I_{FAV}
 I_{FAV}
 I_R
 I_R
 R_{thA}

Kennwerte

 $1.0\text{ A}^1)$
 $0.8\text{ A}^1)$
 $< 0.5\text{ mA}$
 $< 5.0\text{ mA}$
 $< 60\text{ K/W}^1)$


1 Mounted on P.C. Board with 25 mm² copper pads at each terminal
Montage auf Leiterplatte mit 25 mm² Kupferbelag (Lötpad) an jedem Anschluss